

L-Band, GaN/SiC, RF Power Transistor

2.7 - 3.1 GHz | 10W typ | 40% Efficiency typ | 15dB Gain typ | 32 V | 40ms Pulse Length, 50% Duty Cycle

IGN2731L10 is a high power GaN-on-SiC RF power transistor that has been designed for use in S-band radar systems in the 2.7 - 3.1 GHz frequency range. It supplies a minimum of 10 W of output power, with typically >15dB of gain and 40% efficiency. It operates from a 32 V supply voltage. For optimal thermal efficiency, the transistor is housed in a metal-based package with an epoxy-sealed ceramic lid.



FEATURES

- GaN on SiC HEMT Technology
- Output Power >10 W
- Pre-matched Input Impedance
- High Efficiency 40% Typically
- 100% RF Tested Under 40ms Pulse Length, 50% Duty Cycle Conditions
- RoHS and REACH Compliant
- IGN2731L10 has a bolt-down flange, IGN2731L10S is the earless flange option



APPLICATIONS

S-band Radar Systems

Table 1. Absolute Maximum Ratings (Not Simultaneous)

Parameter	Symbol	Value	Units	Test Conditions
DC Drain-Source Voltage	V _{DS}	75	V	25 °C
DC Gate-Source Voltage	V_{gs}	-8 to +1.5	V	25 °C
DC Drain Current	I _D	1.8	A	25 °C
DC Gate Current	I _G	1.8	mA	25 °C
RF Input Power	P _{REIN}	1	W	25 °C
Operating Junction Temperature	$T_{_{\mathtt{J}}}$	-55 to +200	°C	
Storage Temperature	T _{STG}	-55 to +150	°C	
Soldering Temperature	T _{SOLDER}	260 for 10s	°C	

Note: Operation outside the limits given in this table may cause permanent damage to the transistor

Table 2. DC Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
Gate Pinch-Off Voltage	V _P	-5.0			V	$V_{DS} = 32V$, $I_{DS} = 1mA$
Quiescent Gate Voltage	V _Q		-2.5		V	$V_{DS} = 32V, I_{DS} = 15mA$



Table 3. RF Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

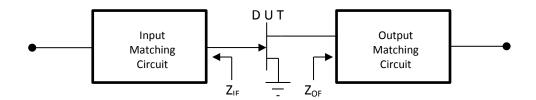
Parameter	Symbol	Min	Тур	Max	Units	Test Conditions	
RF Ouput Power	P _{out, RF}	10		17	W	P _{IN} = 0.4 W	
Gain	G	14	15	16.3	dB	f = 2.7, 2.9, 3.1 GHz	
Drain Efficiency	η	30	40	65	%	40ms Pulse Length, 50% Duty Cycle	
Input return Loss	IRL	7		18	dB		
Pulse Droop	D	-0.7	-0.2	+0.3	dB	$V_{DS} = 32V, I_{DS} = 15mA$	
Load Mismatch Stability	VSWR-S	2:1					
VSWR Withstand	VSWR-LMT	3:1					

Table 4. Thermal Resistance (Case temperature = 25 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Max	Units	Test Conditions
Peak Thermal Resistance, Junction to Case	R _{TH(JC)}			7.5	°C/W	$P_{OUT} = 10W$, 40% Efficiency f = 2.9 GHz 40ms Pulse Length, 50% Duty Cycle $V_{DS} = 32V$, $I_{DS} = 15\text{mA}$

Table 5. Optimum Source & Load Impedances (Case temperature = 25 °C unless otherwise stated)

Frequency (GHz)	Z _{IF}	Z _{of}	Units	Test Conditions
2.7	4.3 - j 5.3	8.1 - J 9.4	Ω	P _{out} = 10W
2.9	3.6 - j 3.0	10.8 - j 9.2	Ω	40ms Pulse Length, 50% Duty Cycle $V_{DS} = 32V, I_{DS} = 15mA$
3.1	3.1 - j 0.8	8.9 - J14.3	Ω	





TYPICAL PERFORMANCE

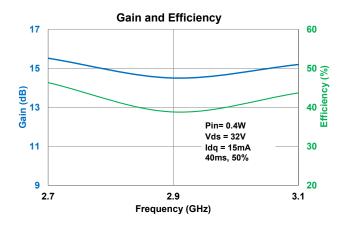


Figure 1

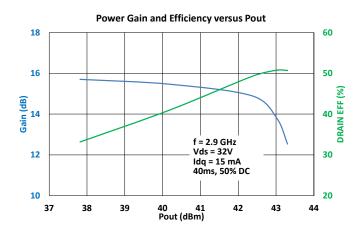


Figure 2

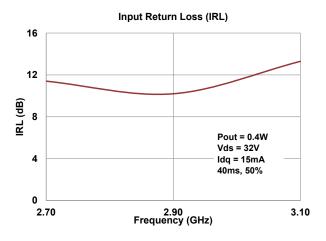


Figure 3

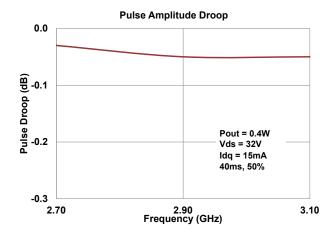
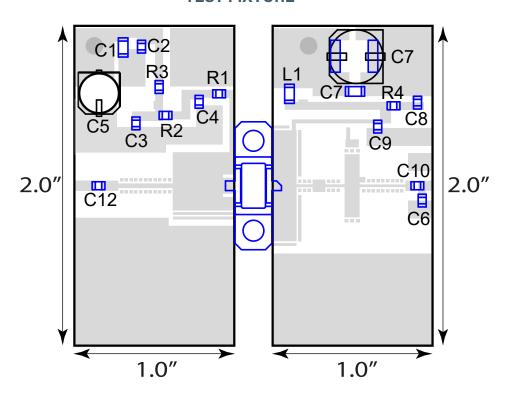


Figure 4



TEST FIXTURE

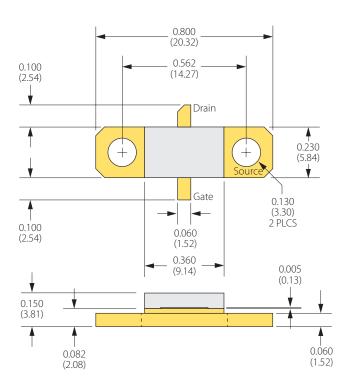


Bill of Materials for IGN2731L10 Test Fixture

Designator	Description	Quantity cososo	DAKIBAL Part Number
C1, C7	CAP 1μF, 1206, 100V	2	GRM31CR72A105KA01L
C2, C3, C8	CAP 0.1μF, 0805, 100V	3	08051A102J4T2A
C4, C9	CAP 5.6pF, 0805, 250V	2	ATC600F5R6CT
C5	CAP 47μ F , 25V	1	600F180JT250XT
C6	CAP 0.8pF, 0805, 250V	1	EEE-FK1J680P
C10, C12	CAP, 12pF, 0805, 250V	2	ATC600F120CT
C11	CAP, 68μF, 63V, Electrolytic	1	EEE-FK1J680P
L1	IND, FB, 330hm, 6A, 1206	1	BLM31PG330S
R1, R2	RES, 100OHM, 0805	2	0603HP-3N9XJB
R3	RES, 470 OHM, 0805	1	ERJ-6GEYJ5R1V
R4	RES, 100 OHM, 0805	1	ERJ-6ENF2000V
PC Board Type	Taconic, 30mil, 1/1oz. Copper	2	RF-35TC-0300-C1/C1



PACKAGE PL32A2



(2.54) Drain 0.230 (5.84)Gate 0.100 0.060 (2.54) (1.52)0.360 0.09 0.005 (9.14)(2.29) (0.13) Source 0.082 (2.08)

0.100

BOLT-DOWN FLANGE OPTION IGN2731L10

EARLESS FLANGE OPTION IGN2731L10S

Dimensions: Inches (mm)



ESD Rating

Parameter	Rating	Standard
ESD Human Body Model (HBM)	TBD	ESDA/JEDEC JS-001-2012
ESD Charged Device Model (CDM)	TBD	JEDEC JESD22-C101F
Moisture Sensitivty Level (MSL) Unlimited Shelf Life		IPC/JEDEC J-STD-020

RoHS Compliance

Integra Technologies, Inc declares that its GaN and LDMOS Transistor Products comply with EU Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863/EU.

REACH Compliance

 $Integra\, Technologies\, supports\, EU\, Regulation\, number\, 1907/2006\, concerning\, the\, Registration, Evaluation, Authorization, and\, Restriction\, of\, Chemicals\, (REACH)\, as\, these\, apply\, to\, Integra\, semiconductor\, products,\, development\, tools,\, and\, shipping\, packaging.$

In support of the REACH regulation, Integra will:

- •Inform customers and recipients of Integra product if they contain any substances that are of very high concern (SVHC) per the European Chemical Agency (ECHA) website.
- •Notify ECHA if any Integra product that contains any SVHCs which exceed guidelines for REACH chemicals by weight per part number and for total content weight per year for all products produced in or imported to the European market.
- Cease shipments of product containing REACH Annex XIV substances until authorization has been obtained.
- •Cease shipment of product containing REACH Annex XVII chemicals when restrictions apply.

Integra has evaluated its materials, BOMs, and product specifications and product and has determined that this transistor conforms to all REACH and SVHC regulations and guidelines. Integra has implemented actions and control programs that will assure continued compliance.

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DEFINITIONS:

DATA SHEET STATUS

Advanced Specification - This data sheet contains Advanced specifications.

Preliminary Specification - This data sheet contains specifications based on preliminary measurements and data.

Final Specification - This data sheet contains final product specifications.

MAXIMUM RATINGS Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.

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